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H8/300L Super Low Power Series

Subtraction of Multiple-Precision Binary Numbers (SUB2)

Introduction

The software SUB2 subtracts a multiple-precision binary number from another multiple-precision binary number and places the result in the data memory where the minuend was set.

Target Device

H8/38024

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1. Arguments

Description	Memory area	Data length (bytes)
Input	Minuend and subtrahend byte count	R0L
	Start address of minuend	R3
	Start address of subtrahend	R4
Output	Start address of result	R3
	Error	Z flag (CCR)
	Borrow	C flag (CCR)

2. Changes to Internal Registers and Flags

R0	R1	R2	R3	R4	R5	R6	R7
×	×	×	○	×	×	—	—
I	U	H	U	N	Z	V	C
—	—	×	—	×	○	—	○

Legend

- : No change
- ×: Undefined
- : Result

3. Specifications

	Program memory (bytes)	
	42	
	Data memory (bytes)	
	0	
	Stack (bytes)	
	0	
	Clock cycle count	
	7170	
	Reentrant	
	Possible	
	Relocation	
	Possible	
	Interrupt	
	Possible	

4. Notes

The clock cycle count (7170) in the specifications for subtraction of 255 bytes from 255 bytes.

5. Description

5.1 Details of functions

1. The following arguments are used with the software SUB2:

R0L: Sets, as an input argument, the byte count of a minuend and the byte count of a subtrahend in 2-digit hexadecimal.

R3: Sets, as an input argument, the start address of the data memory area where the minuend is placed. After execution of the software SUB2, the start address of the result is placed in this register.

R4: Sets, as an input argument, the start address of the data memory area where the subtrahend is placed.

Z flag (CCR): Indicates an error in data length as an output argument.

Z flag = 0: The data byte count (R0L) was not 0.

Z flag = 1: The data byte count (R0L) was 0, indicating an error.

C flag (CCR): Determines the presence or absence of a borrow after software SUB2 execution as an output argument.

C flag = 0: No borrow occurred in the result.

C flag = 1: A borrow occurred in the result. (See figure 2)

2. The following figure illustrates the execution of the software SUB2. When the input arguments are set as shown in (1), the result of subtraction is placed in the data memory area as shown in (2).

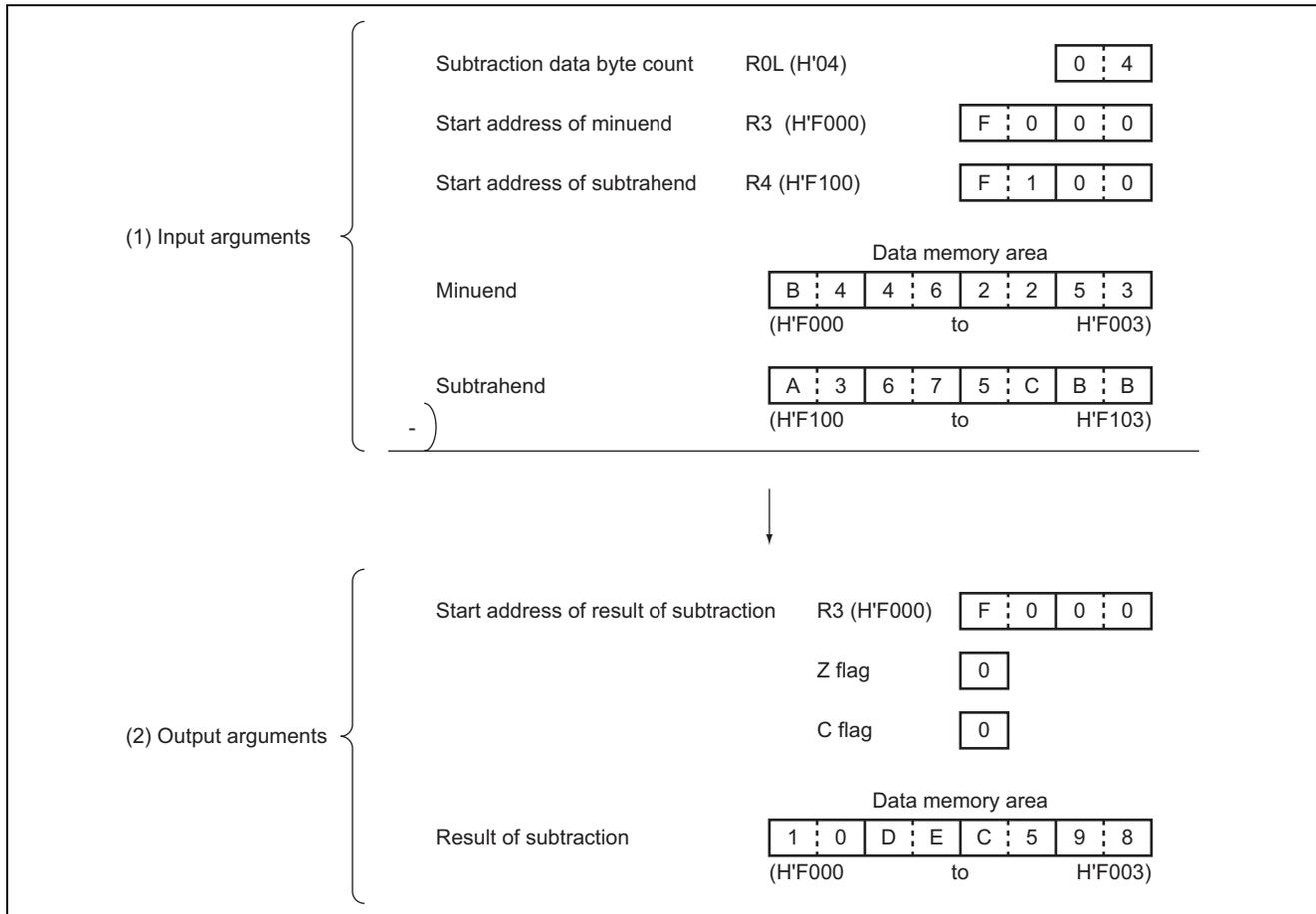


Figure 1 Example of Software SUB2 Execution

Figure 2 shows an example of subtraction with a borrow that has occurred in the result.

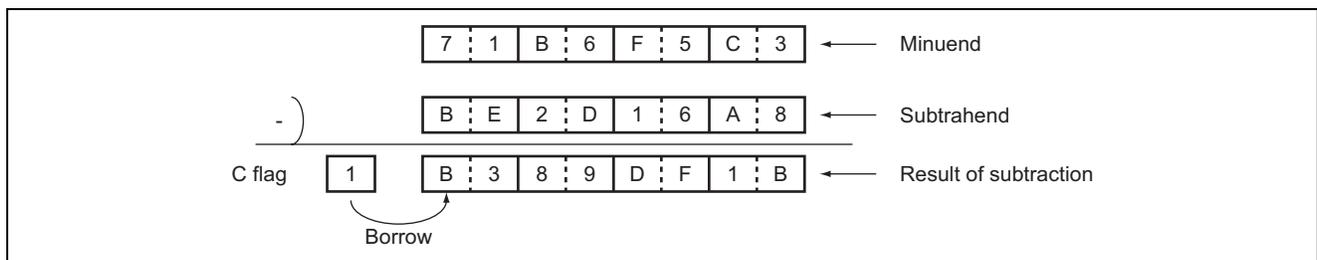


Figure 2 Example of Subtraction with a Borrow

5.2 Notes on usage

1. When the upper bits are not used (see figure 3), set them to 0. The software SUB2 performs byte-based subtraction; when 0 are not set in the unused upper bits, a correct result cannot be obtained because the subtraction is done on the numbers including indeterminate data.

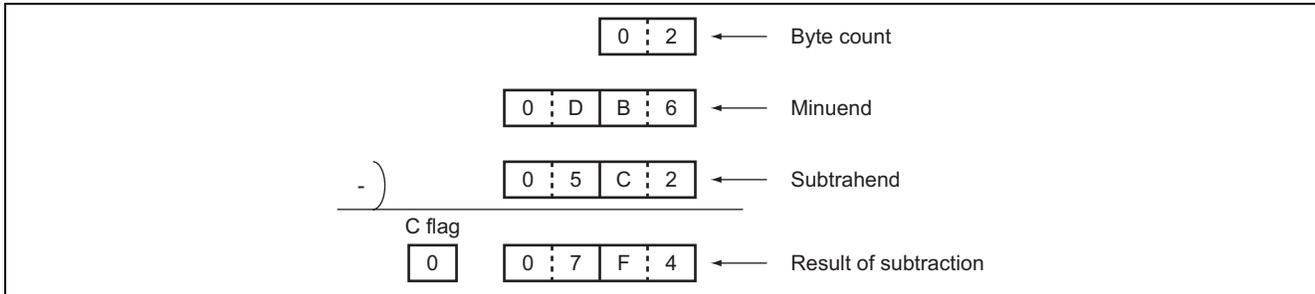


Figure 3 Example of Subtraction with Upper Bits Unused

2. After execution of the software SUB2, the minuend will be lost because the result is placed in the data memory area where the minuend was set. When the minuend is still needed after software SUB2 execution, save it in memory.

5.3 Data memory

The software SUB2 uses no data memory.

5.4 Example of usage

This is an example of subtracting 8 bytes of data. Set the start addresses of a byte count, a minuend and a subtrahend in the registers and call the software SUB2 as a subroutine.

WORK1	. RES. B	1	-----	{ Reserve a data memory area in which the user program places a byte count.
WORK2	. RES. B	8	-----	{ Reserve a data memory area in which the user program places an 8-byte binary minuend.
WORK3	. RES. B	8	-----	{ Reserve a data memory area in which the user program places an 8-byte binary minuend.
.
MOV. B		@WORK1, R0L	-----	{ Place the byte count set by the user program in the input argument (R0L).
MOV. W		#WORK2, R3	-----	{ Place the start address of the minuend set by the user program in the input argument (R3).
MOV. W		#WORK3, R4	-----	{ Place the start address of the subtrahend set by the user program in the input argument (R4).
		JSR	@SUB2	----- { Call the software SUB2 as a subroutine.
		BCS	BORROW	----- { Branch to the borrow processing routine when a borrow has occurred in the result of subtraction.
		.	.	.
		.	.	.
BORROW		Borrow processing routine		

5.5 Operation

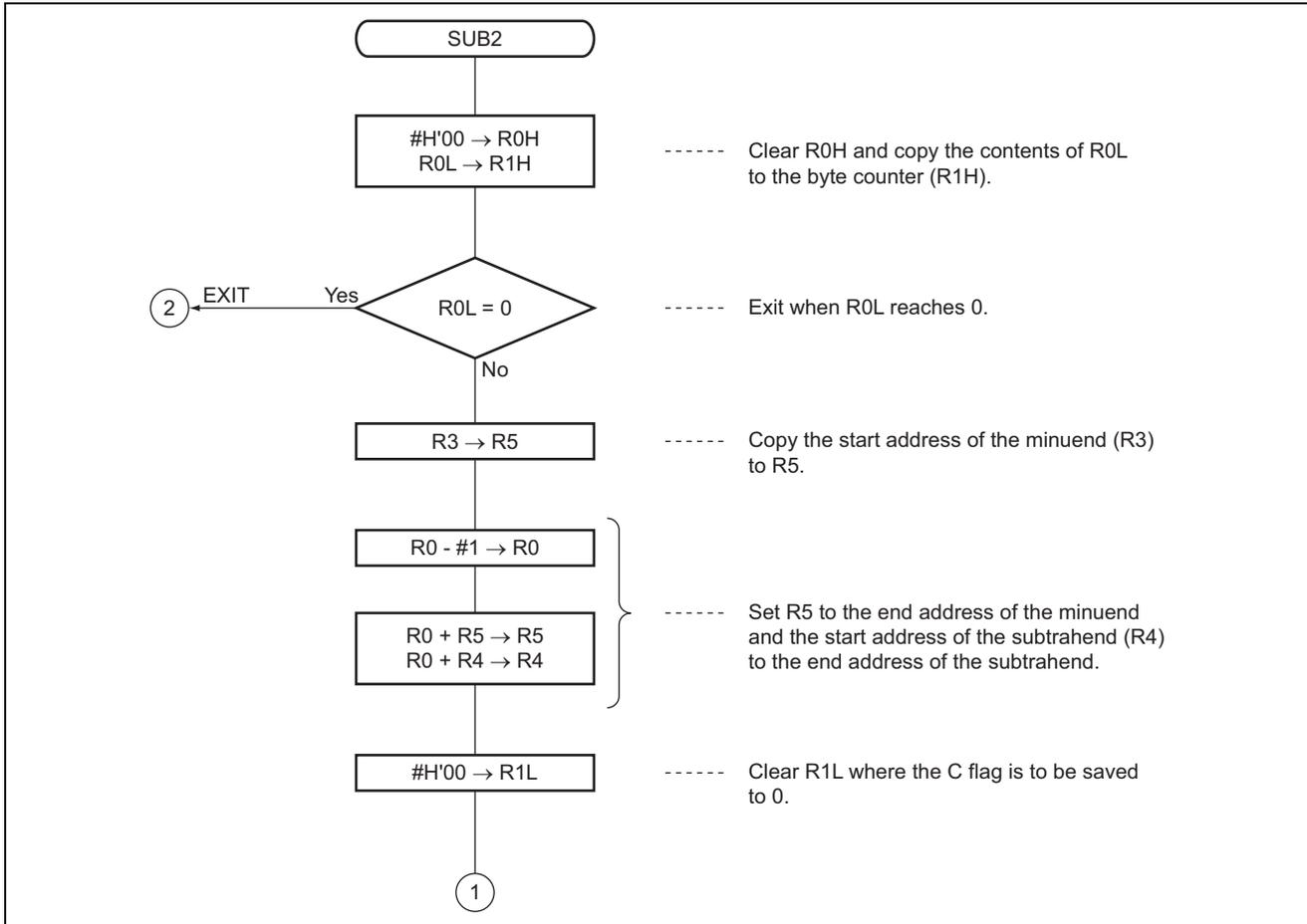
1. Subtraction of multiple-precision binary numbers can be done by repeating a subtract instruction with a carry flag (SUBX.B) as the minuend and subtrahend data are placed in registers on a byte basis.
2. The end address of the data memory area containing the minuend is placed in R3, and the end address of the data memory area containing the subtrahend is placed in R4.
3. R1L is cleared so that the C flag can be saved there.
4. The minuend and subtrahend are loaded in R2L and R2H respectively, byte by byte, starting at their end address and equation 1 is executed:

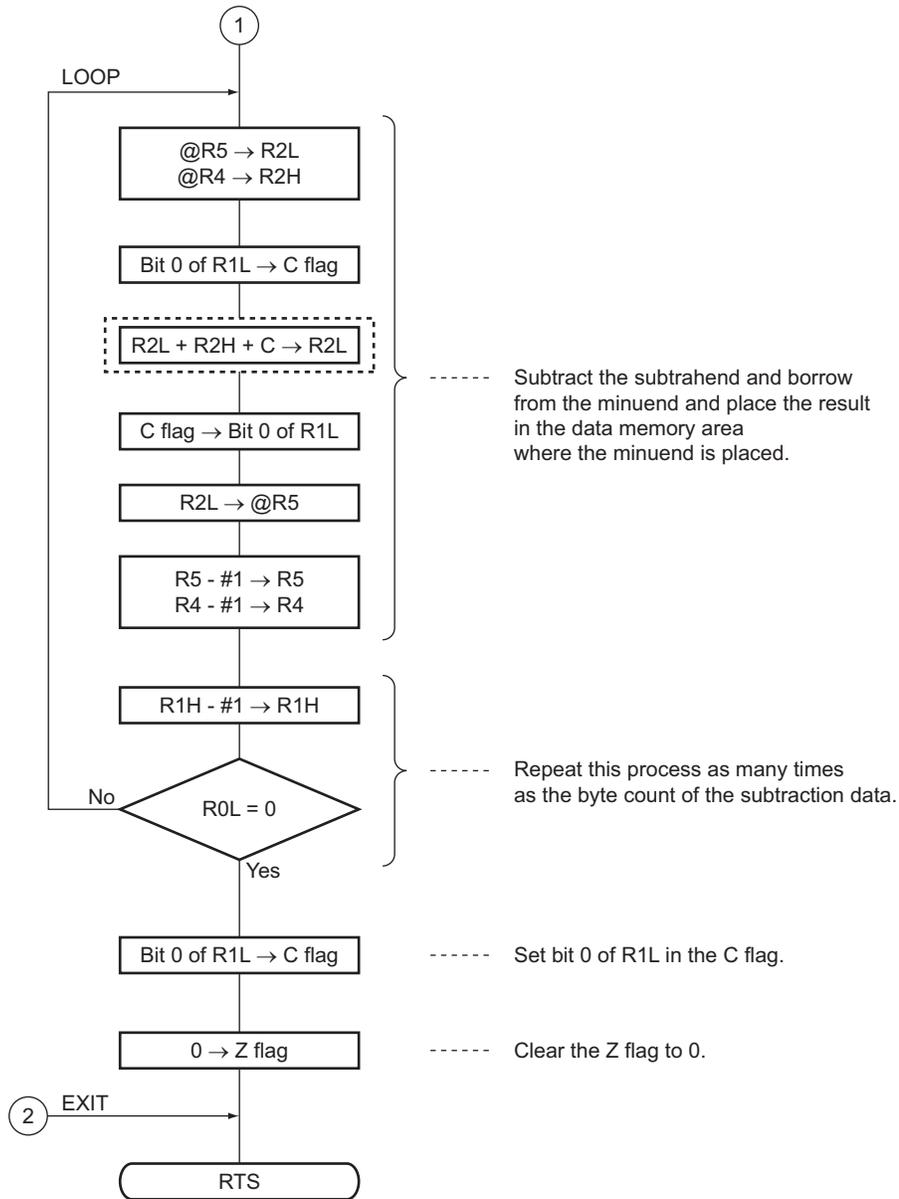
$$\left. \begin{array}{l} \text{Minuend} - \text{subtrahend} - C \rightarrow R2L \\ R2L \rightarrow @R3 \end{array} \right\} \text{----- equation 1}$$

where the C flag indicates a carry that may occur in the result of subtraction of the lower bytes.

5. The result of step 4 is placed in the data memory area for the minuend.
6. R3, R4, and R0L are decremented each time the operation of steps 4 and 5 has been finished. This processing is repeated until R0L reaches 0.

6. Flowchart





Note: SUB2 is the same as ADD2, ADDD2 and SUBD2 except for the stop surrounded by dotted lines.

7. Program List

```

*** H8/300 ASSEMBLER VER 1.0B ** 08/18/92 10:00:06
PROGRAM NAME =
1          ;*****
2          ;*
3          ;*      00 - NAME      :MULTIPLE-PRECISION BINARY SUBTRACTION
4          ;*                               (SUB2)
5          ;*
6          ;*****
7          ;*
8          ;*      ENTRY      :R0L (BYTE LENGTH OF DATA)
9          ;*                               R3 (START ADDRESS OF MINUEND)
10         ;*                               R4 (START ADDRESS OF SUBTRAHEND)
11         ;*
12         ;*      RETURNS   :R3 (START ADDRESS OF RESULT)
13         ;*                               Z flag OF CCR (Z=0;TRUE , Z=1;FALSE)
14         ;*                               C flag OF CCR (C = 0;TRUE , C = 1;BORROW)
15         ;*
16         ;*****
17         ;
18 SUB2_cod C    0000          .SECTION          SUB2_code, CODE, ALIGN=2
19                               .EXPORT          SUB2
20         ;
21 SUB2_cod C    00000000 SUB2 .EQU $              ;Entry point
22 SUB2_cod C    0000 F000     MOV.B    #H'00,R0H    ;Clear R0H
23 SUB2_cod C    0002 0C81     MOV.B    R0L,R1H    ;Set byte counter(R1H)
24 SUB2_cod C    0004 4722     BEQ     EXIT      ;Branch if R0L=0
25 SUB2_cod C    0006 0D35     MOV.W   R3,R5      ;R3 -> R5
26 SUB2_cod C    0008          MAIN
27 SUB2_cod C    0008 1B00     SUBS.W  #1,R0      ;Decrement R0
28 SUB2_cod C    000A 0905     ADD.W   R0,R5      ;Adjust minuend start address(R5)
29 SUB2_cod C    000C 0904     ADD.W   R0,R4      ;Adjust subtrahend start address(R4)
30 SUB2_cod C    000E F900     MOV.B   #H'00,R1L  ;Clear R1L
31 SUB2_cod C    0010          LOOP
32 SUB2_cod C    0010 685A     MOV.B   @R5,R2L    ;Load minuend
33 SUB2_cod C    0012 6842     MOV.B   @R4,R2H    ;Load subtrahend
34 SUB2_cod C    0014 7709     BLD     #0,R1L     ;Load bit 0 of R1L to C flag
35 SUB2_cod C    0016 1E2A     SUBX.B  R2H,R2L    ;Subtraction
36 SUB2_cod C    0018 6709     BST     #0,R1L     ;Store C flag to bit 0 of R1L
37 SUB2_cod C    001A 68DA     MOV.B   R2L,@R5    ;Store result
38 SUB2_cod C    001C 1B05     SUBS.W  #1,R5      ;Decrement minuend address
39 SUB2_cod C    001E 1B04     SUBS.W  #1,R4      ;Decrement subtrahend address
40 SUB2_cod C    0020 1A01     DEC.B   R1H        ;Decrement byte counter
41 SUB2_cod C    0022 46EC     BNE     LOOP      ;Branch if not R0L=0
42         ;
43 SUB2_cod C    0024 7709     BLD     #0,R1L     ;Load bit 0 of R1L to C flag
44 SUB2_cod C    0026 06FB     ANDC   #H'FB,CCR   ;Clear Z flag
45 SUB2_cod C    0028          EXIT
46 SUB2_cod C    0028 5470     RTS
47         ;
48         .END
****TOTAL ERRORS 0
****TOTAL WARNINGS 0

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